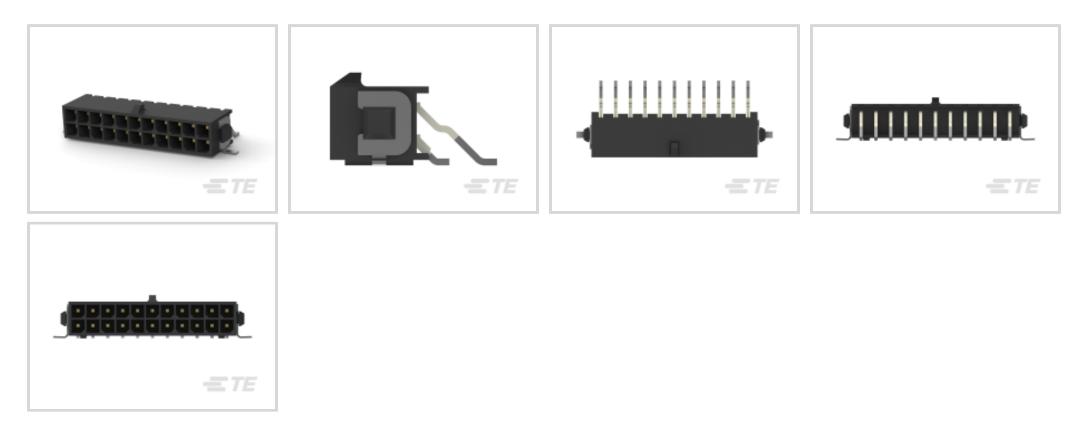


MATE-N-LOK | Micro MATE-N-LOK

TE Internal #: 5-794629-2 Rectangular Power Connectors, Header, Plug, Wire-to-Board, 22 Position, 3 mm [.118 in] Centerline, Printed Circuit Board, UL 94V-0, Micro MATE-N-LOK

View on TE.com >

Connectors > Power Connectors > Rectangular Power > Rectangular Power Connectors



Rectangular Power Connector Type: Header

Connector & Housing Type: Plug

Connector System: Wire-to-Board

Number of Positions: 22

Centerline (Pitch): 3 mm [.118 in]

Features

connectivity

Product Type Features

Header Type	Fully Shrouded	
Rectangular Power Connector Type	Header	
Connector & Housing Type	Plug	
Connector System	Wire-to-Board	
Sealable	No	
Connector & Contact Terminates To	Printed Circuit Board	
Configuration Features		
Number of Positions	22	
Number of Fositions	22	
PCB Mount Orientation	ZZ Right Angle	
PCB Mount Orientation	Right Angle	
PCB Mount Orientation Number of Power Positions	Right Angle 22	
PCB Mount Orientation Number of Power Positions Number of Rows	Right Angle 22	

C For support call+1 800 522 6752

Rectangular Power Connectors, Header, Plug, Wire-to-Board, 22 Position, 3 mm [.118 in] Centerline, Printed Circuit Board, UL 94V-0, Micro MATE-N-LOK



Contact Termination Area Plating Finish	Matte
Multiple Contact Types	Without
Contact Current Rating (Max)	5 A
Contact Retention Within Housing	Without
Contact Type	Pin
PCB Contact Termination Area Plating Material	Tin
Contact Mating Area Plating Material	Gold
Contact Mating Area Plating Material Thickness	.76 μm[30 μin]
Contact Termination Area Plating Thickness	3.81 – 8.89 μm[150 – 350 μin]
Termination Features	
Termination Post & Tail Length	3.56 mm[.14 in]
Termination Method to Printed Circuit Board	Surface Mount
Mechanical Attachment	
Strain Relief	Without
Mating Alignment Type	Polarization
Mating Alignment	With
PCB Mount Alignment	Without
Panel Mount Feature	Without
PCB Mount Retention	With
PCB Mount Retention Type	Hold-Down Post
Connector Mounting Type	Board Mount
Mating Retention	With
Mating Retention Type	Locking Tab
Housing Features	
Centerline (Pitch)	3 mm[.118 in]
Housing Color	Black
Housing Material	High Temperature Nylon
Boardlock Material	Phosphor Bronze
Dimensions	
Row-to-Row Spacing	3 mm[.118 in]
Width	10.1 mm
PCB Thickness (Recommended)	1.6 mm[.063 in]

Rectangular Power Connectors, Header, Plug, Wire-to-Board, 22 Position, 3 mm [.118 in] Centerline, Printed Circuit Board, UL 94V-0, Micro MATE-N-LOK



Height	3 mm
Usage Conditions	
Operating Temperature Range	-40 - 105 °C[-40 - 221 °F]
Operation/Application	
Circuit Application	Power
Industry Standards	
CSA Rating	Certified
Glow Wire Material Rating	Material with GWFI 850°C, Material with GWIT ≥ 775°C
UL Flammability Rating	UL 94V-0
Glow Wire Rating	GWT 750°C (Without Flame)
Agency/Standard Number	E28476
Agency/Standard	CNR, USR
UL Rating	Recognized
CSA File Number	LR7189
VDE Tested	No

Packaging Features

Packaging	N / a + la a al	

rackaging method		

Packaging Quantity

Box & Tray, Tray

150

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JUNE 2022 (224) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Reflow solder capable to 260°C

Rectangular Power Connectors, Header, Plug, Wire-to-Board, 22 Position, 3 mm [.118 in] Centerline, Printed Circuit Board, UL 94V-0, Micro MATE-N-LOK



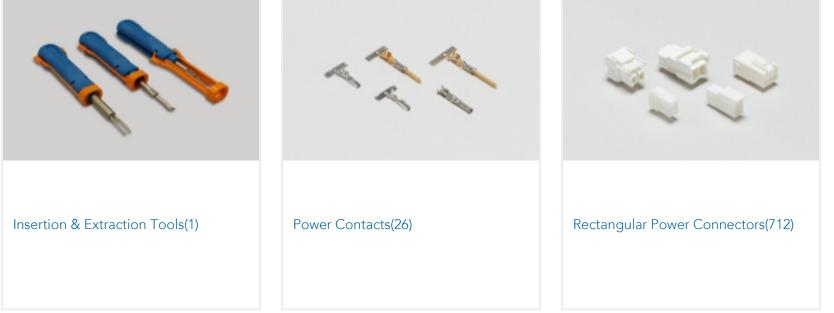
Product Compliance Disclaimer

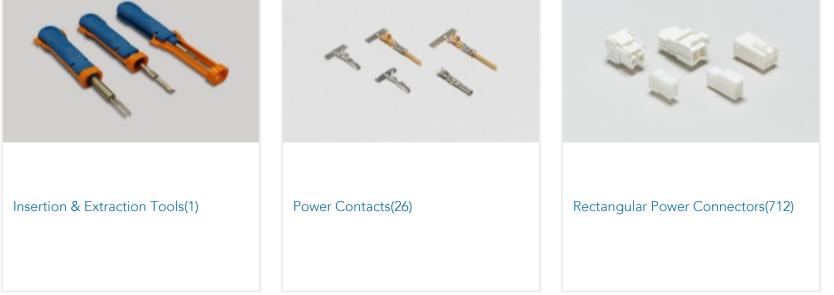
This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-onreach

Compatible Parts



Also in the Series Micro MATE-N-LOK





Documents

Product Drawings 22P MICRO MNL ASSY, R/A, SMT, LF

English

CAD Files

3D PDF

3D

Customer View Model ENG_CVM_CVM_5-794629-2_K.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_5-794629-2_K.3d_igs.zip

Rectangular Power Connectors, Header, Plug, Wire-to-Board, 22 Position, 3 mm [.118 in] Centerline, Printed Circuit Board, UL 94V-0, Micro MATE-N-LOK



English

Customer View Model ENG_CVM_CVM_5-794629-2_K.3d_stp.zip

English

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Datasheets & Catalog Pages

SOFT_SHELL_PIN_AND_SOCKET_CONNECTORS_CATALOG

English

MICRO MATE-N-LOK CONNECTOR SYSTEM

English

1773458-4_MICRO_MATE_N_LOK_CONNECTOR_SYSTEM_QRG

English

Product Specifications

Product Specification

English

Agency Approvals VDE Certificate

English